

Building Monitoring Needs for PWS Technologies

Teja Kuruganti Ph.D.
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ORNL is managed by UT-Battelle, LLC for the US Department of Energy

Opportunity Space

Buildings consume 74% electricity produced in the US

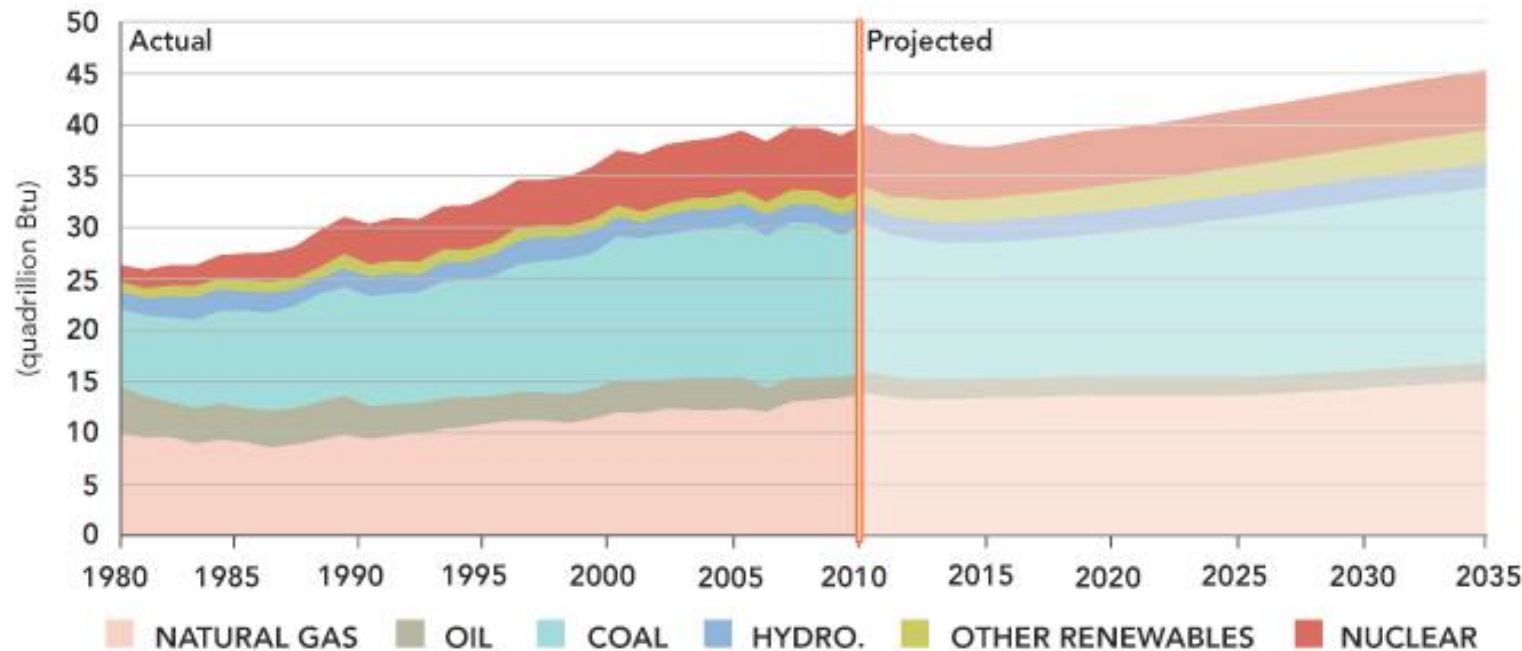
Buildings have the potential to reduce their consumption by 20%-30% (18 quads or 2,500 million tons of oil) through advanced sensors and controls

Potential nationwide value of demand dispatch could be several billion dollars yearly in reduced energy costs with 10% participation (NETL, Demand Dispatch – Intelligent Demand for a More Efficient Grid, August 2011)

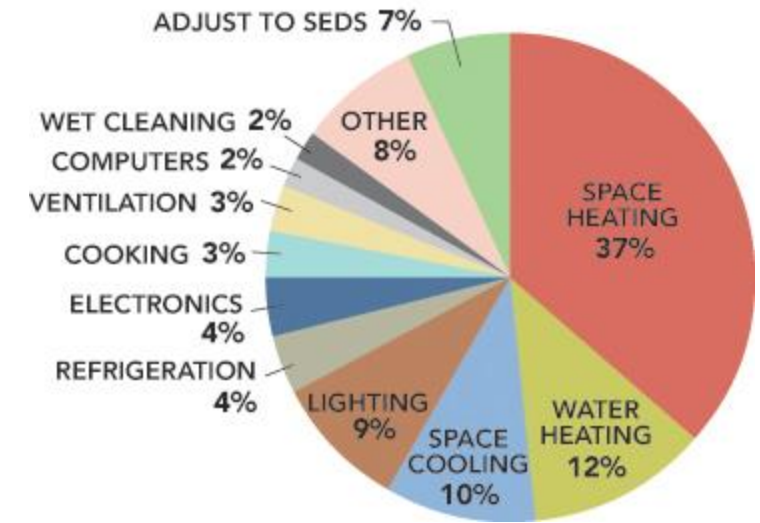
One-fourth of the 713 GW of US electricity demand in 2010 could be dispatchable

90% of the commercial buildings are < 50,000 ft² and need aggregation

BUILDINGS SECTOR PRIMARY ENERGY CONSUMPTION



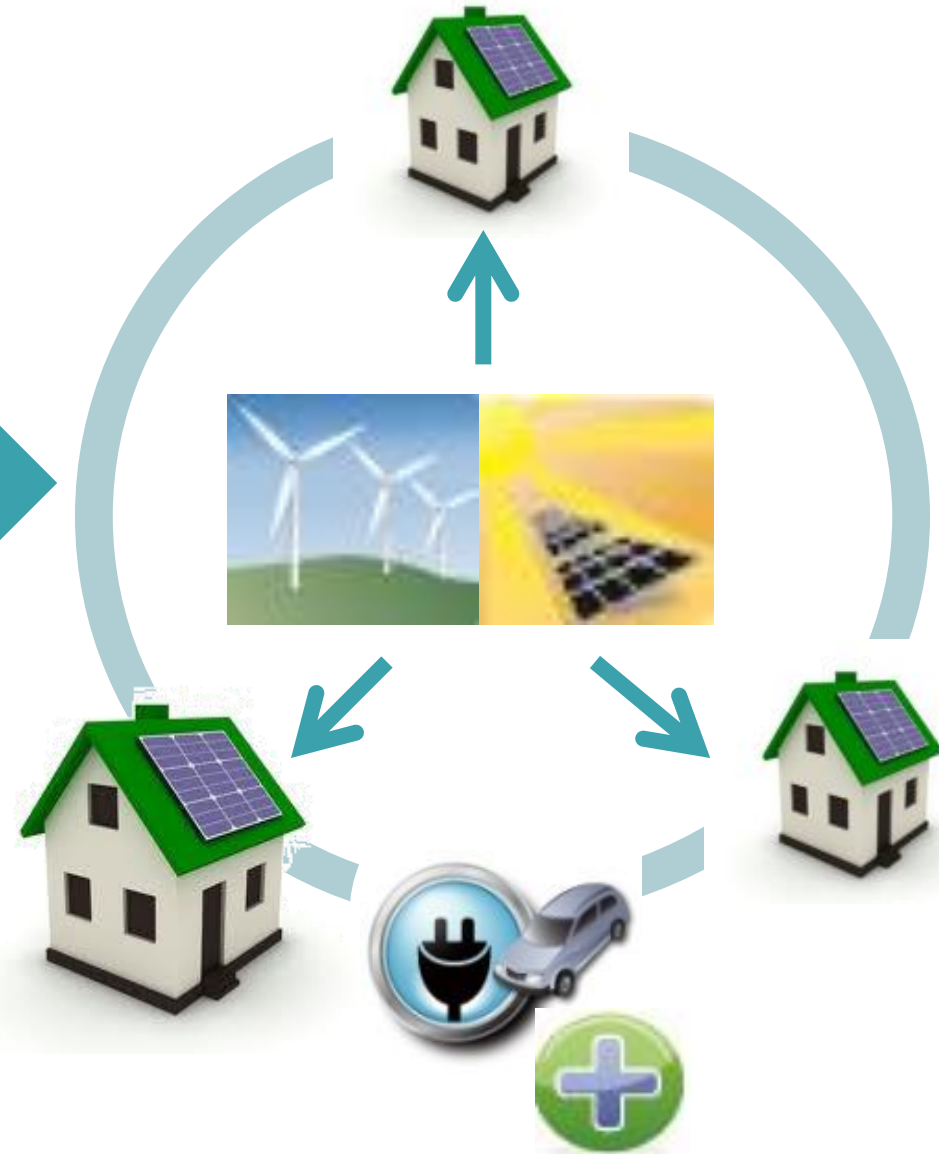
BUILDINGS SITE ENERGY CONSUMPTION BY END USE



5.5 million commercial, 117 million residential, projected to be 80% of load growth through 2040

Sensors will lead to significant energy savings for the market

Buildings will be self-configuring, self-commissioning and self-learning such that they optimize operation, maximize energy savings cost effectively and can participate in transactions within the building, between buildings and with the grid

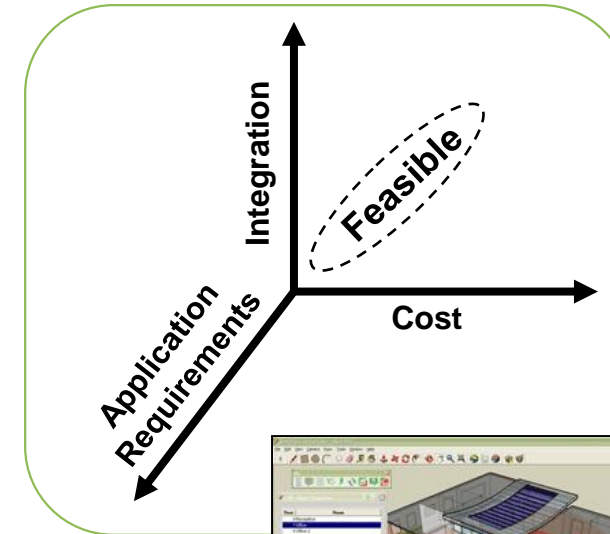
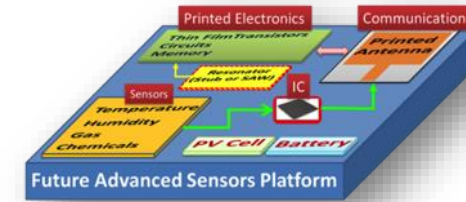


Requirements for Building Monitoring

Impact on Buildings Technology

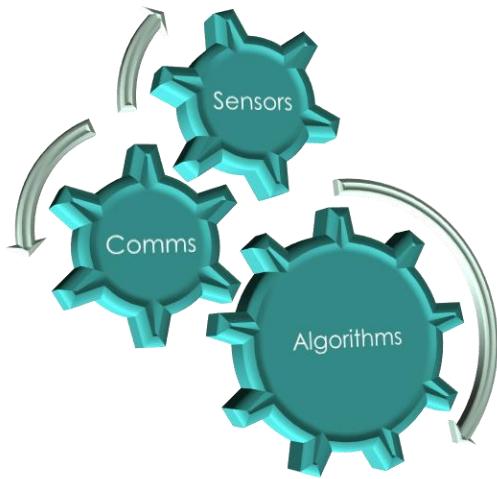
Advanced Sensor, Control Technology Brings Big Growth to Building Energy Management Market:

- **Market Growth:** 17% compound annual rate to become a \$2.14 billion industry by 2020(Lux Research)
- Non-Orthogonal Multi-dimensional requirements for low-cost wireless sensors
 - Application Requirements (data rate, sensor accuracy, sampling rate, battery, RF communications)
 - Integration Requirement (printable materials, functionality, device/sensor integration, regulations)
 - Cost: Low-cost, Manufacturing infrastructure (COTS wireless sensors are still at a high cost per node)
- ASHRAE Standards 90.1, 90.2, 55, 62.1, and 189.1
- IECC, IBC, and NFPA 5000 code.

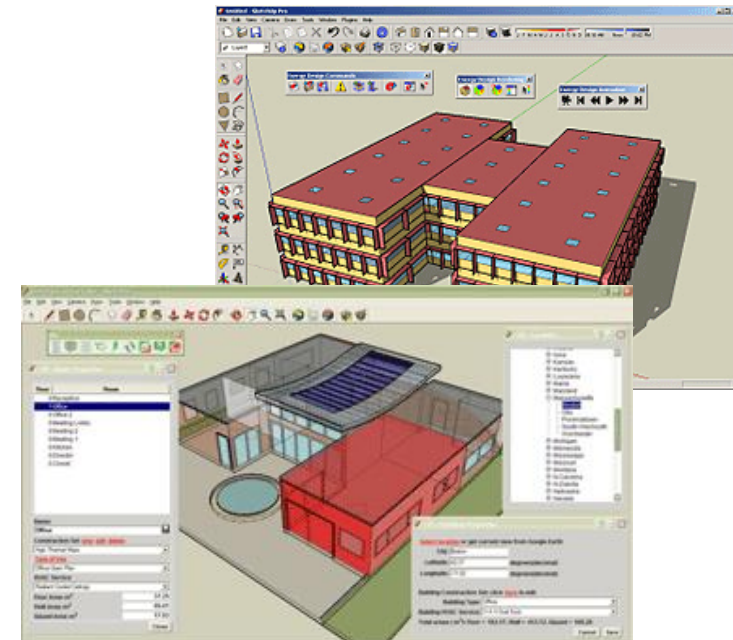
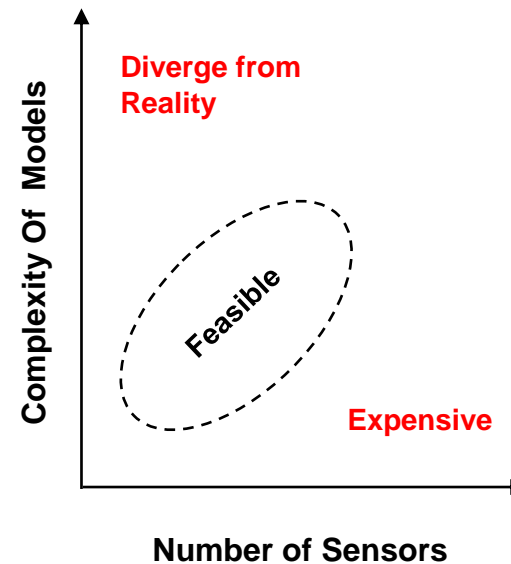
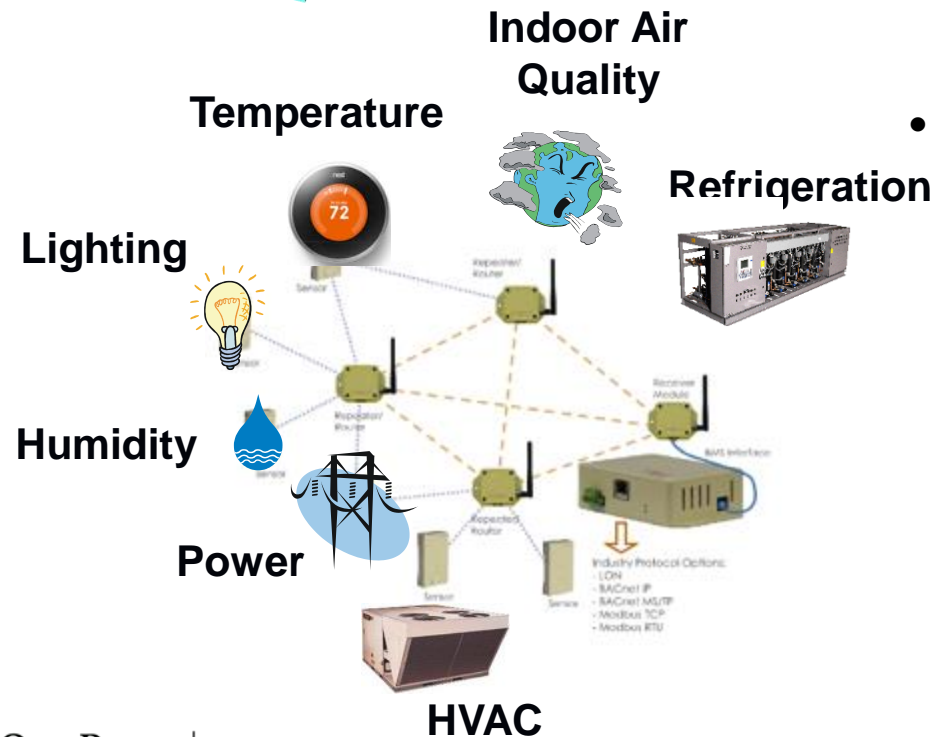


Self-powered, Wireless Technology will Enable Multifunctional Sensor Platform at feasible cost and reliability

Connectivity – Observe & Control

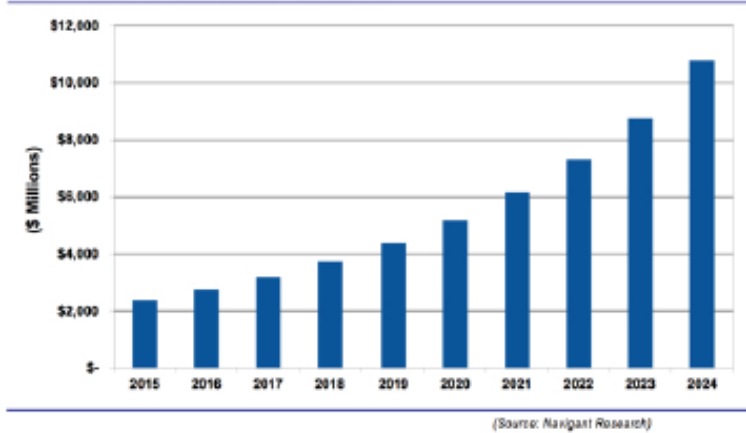


- **Today's** stock of **buildings** are noticeably “**un-connected**”
 - Limited by existing control and coordination
 - Advanced automation only in large buildings
 - Value streams are often hidden and untapped
- Large-scale deployment of **clean energy technologies** - building equipment integration and electric grid coordination
- **Improved integration** approaches for deploying technology can **enable new services**
- Retrofit deployment with ROI in 1-2 years



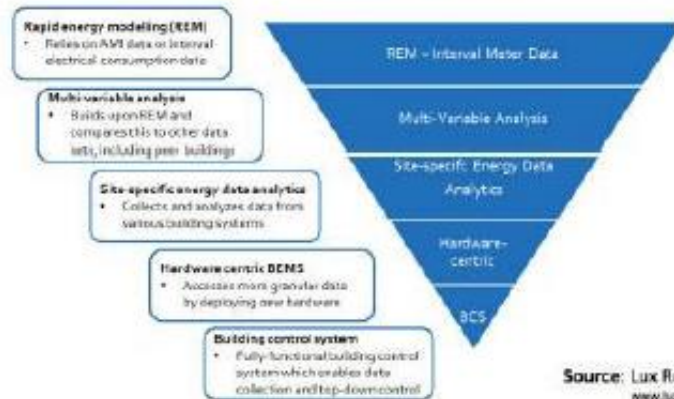
Market is Growing

Chart 1.1 BEMS Revenue, World Markets: 2015-2024



- Building Energy Management Systems (BEMS) attracted \$1.4 B in VC Funding from 2000-2014 (26% of all investment in building energy technology): 30% software, 27% energy services, 25% sensors and controls; 13% semiconductors
- Market transitioning from BAS-dominant to BEMS. In 2020, about 77% of the \$2.14 billion U.S. market will comprise BEMS applications, and 40% will come from buildings below 50,000 square feet.
- U.S. market for sensors and controls for BEMS will rise at a 17% compound annual growth rate to \$2.14 billion in 2020.

BEMS products vary in complexity and implementation with data sets available and hardware or software elements



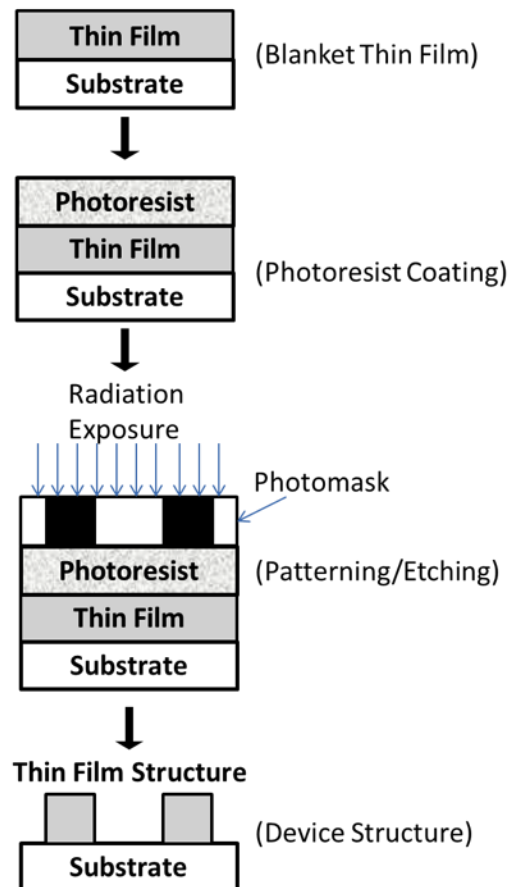
Source: Lux Research, Inc.
www.luxresearchinc.com

Source: 2016 Peer Review Presentation on S&C Overview

Additive Integration Approaches

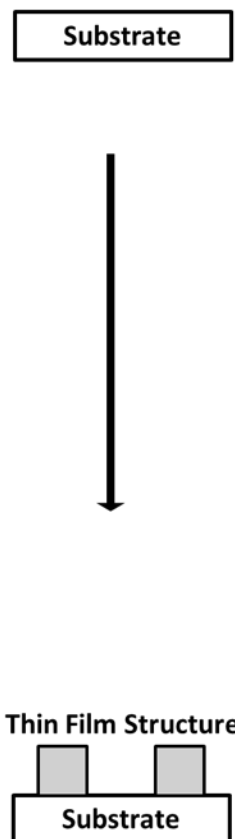
CMOS Processing

Conventional IC Process



Resolution: 0.02 μ m

Additive Printing Technology

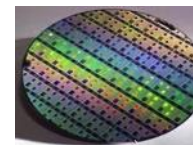


Resolution: 10 μ m

Demands on Material Performance do not change significantly

Substrate Integration

Si: CMOS



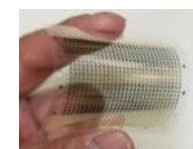
$T < 1000^{\circ}\text{C}$

Glass: Transparent Electronics



$T < 600^{\circ}\text{C}$

Plastic: Low-cost Electronics



$T < 200^{\circ}\text{C}$

3D Structures: Free-form



Resolution: 50 μ m

Integration Opportunity: Mask-less Design

Sensors – Peel-and-Stick Wireless Sensors

Thin Film Deposition

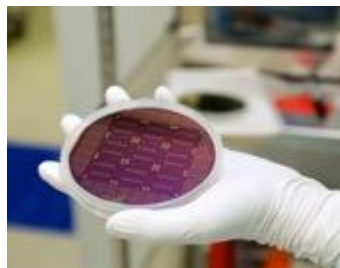


Inkjet Printing

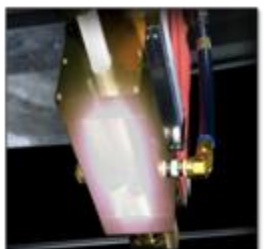
Ultrasonic Spray

Sputtering

E-beam Evaporation



Low Temperature Photonic Curing



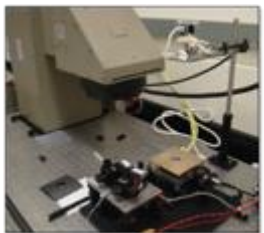
PulseForge 3300

Vortek-300

Vortek-500



Materials and Device Characterization



CNMS

CATS Lab

NSTL

EMC2

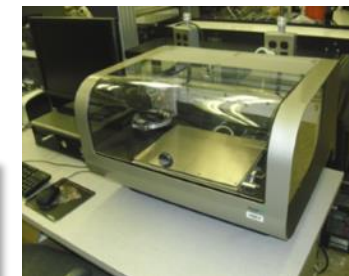
RF-Clean Room

RF Test Setups

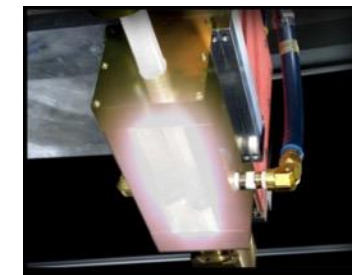


Target Technologies

- ❖ **Sensors**
(Chem-Bio, Temperature, Environment, Mechanical)
- ❖ **Optoelectronics**
(Phosphor, OLED, Display)
- ❖ **Batteries**
(CNT, Nanoparticles, C-fiber)
- ❖ **RF Electronics**
(Energy Harvesting, RF Tags)
- ❖ **Photovoltaics**
(a-Si, CIGS, CZTS, Polymer)
- ❖ **Organic Electronics**
(PV, Sensor, TFTs, RF)



Print components on
flexible substrates



Low temperature
photonic curing



Add what is
unprintable,
demonstrate
platform



Engage industry partner
to manufacture prototypes
for OEMs

Transactive Control - It is a delicate balancing act

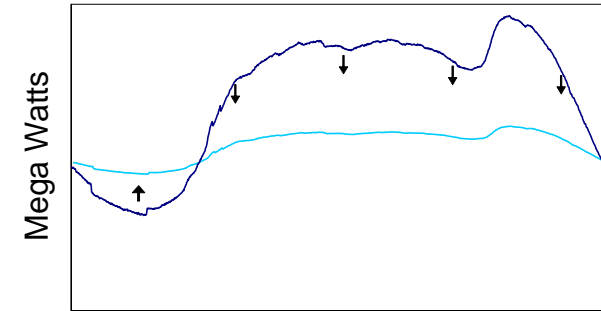
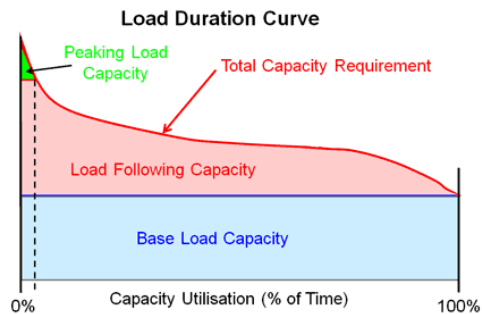
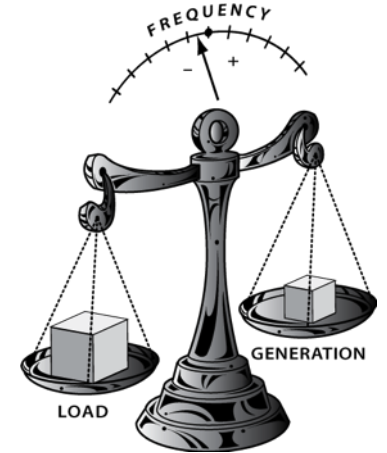
Load >
Generation –
under
frequency



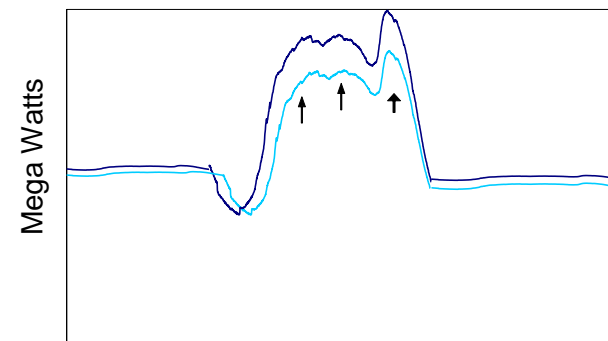
Load <
Generation –
over
frequency



When you see
frequency
change – it is
too late.



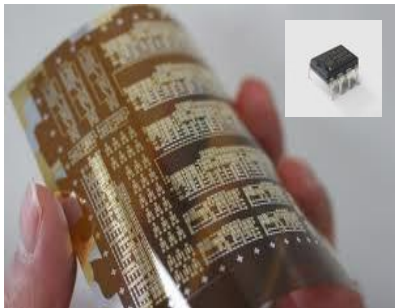
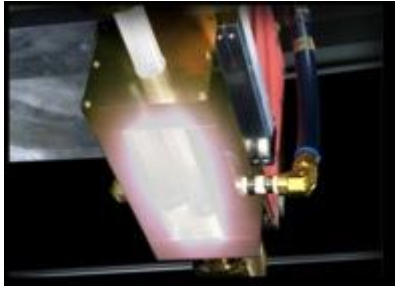
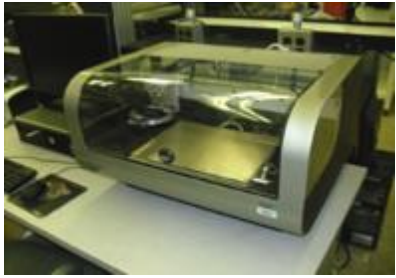
**Reduce Energy
Intensity and
Increase Energy
Efficiency**



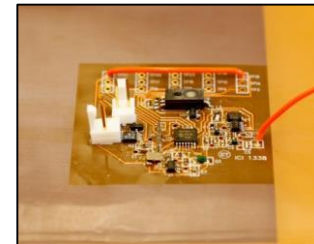
**Increase Load Flexibility
and Improve Grid
Resiliency**



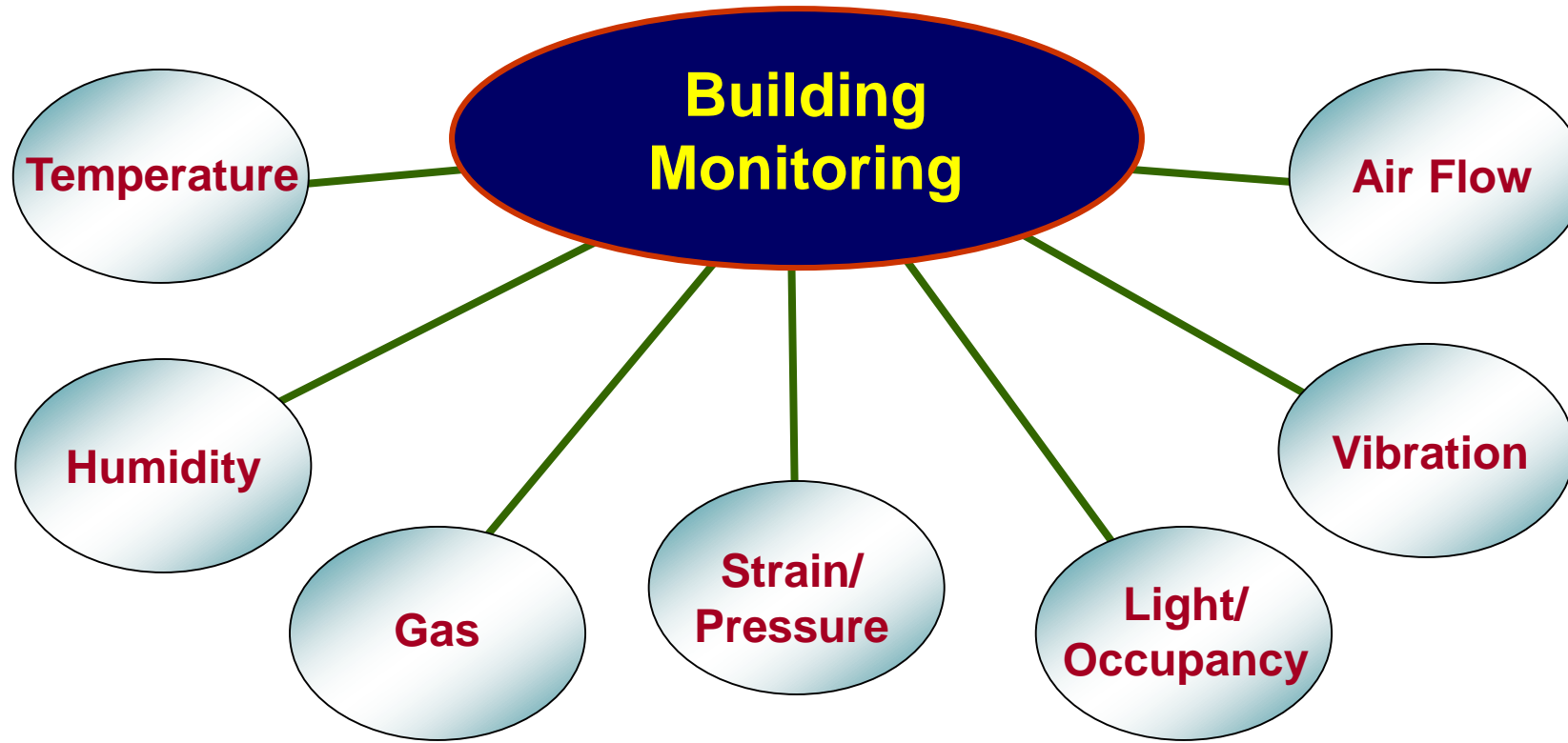
Next Generation Sensors – Passive Sensing



- Passive communication scheme
- Sensor miniaturization
- Reduced infrastructure cost of networking through increased range
- Multi-modal sensors in a single platform
- Additive, roll-to-roll manufacturing compatible



Sensor Needs: Materials, Process, and Devices



- In-situ sensing for equipment conditioning monitoring - often times limited power availability
- A clear understanding of process-structure-property correlation is critical to evaluate the technology potential

Summary

- Significant energy efficiency gains possible with ubiquitous sensing
- Reliability the grid can be significantly improved by responsive loads
- Enable intelligence in low-touch retrofits
- Seamless deployment requires:
 - Advanced Monitoring
 - Innovative “real” and “virtual” sensors
 - Automated Response
 - Distributed control strategies
 - Scalable Testing Platforms
 - Large-scale simulation platforms



Discussion



OAK RIDGE NATIONAL LABORATORY
MANAGED BY UT-BATTELLE
FOR U.S. DEPARTMENT OF ENERGY

A large, curved, light-colored stone or concrete sign stands in a landscaped area. The sign is illuminated from below by several small, circular lights. In the background, a modern building with a large glass facade is visible against a clear blue sky. The foreground is filled with green grass and some small trees.